DATE: June 15, 2023

# 产品规格书

### SPECIFICATION FOR APPROVAL



用户名称	CUSTOMER:	Quartz 1
产品描述	DESCRIPTION:	Monolithic Crystal Filter UM-5*2 21.4MHz
产品部品号	MANUFACTURER PART NO.:	FT21M20B
用户部品号	CUSTOMER PART NO:	
使用于机型	USED IN MODEL:	

	承 认	APPROVAL
工程部	品质部	采购部
TECHNOLOGY DEPT.	QUALITY DEPT.	PURCHASING DEPT.



#### 深圳市炬烜科技有限公司

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#### 1. QUARTZ CRYSTAL UNIT SPECIFICATION

1. General

1.1 Model Name : FT21M20B

1.2 Holder type : UM-5\*2

2. Electrical Specification:

2.1 Frequency: 21.400MHz

2.2 Mode of Oscillation AT Fundamental

2.3 Pass Band Width:  $\pm 10$ KHz min (at 3dB)

2.4 Stop Band Width:  $\pm 28$ KHz max (at 40dB)

2.5 Pass Band Ripple: 1.0dB max

2.6 Insertion Loss: 2.0dB max

2.7 Attenuation Guarantee : 65dB min (f0+300~1000KHz)

80dB min (f0-200~1000KHz)

2.8 Terminating Impedance : IN:  $2000\Omega//2.0pF$ 

OUT:  $2000\Omega//2.0pF$ 

Coupling capacitance(C2): 6.0pF

2.9 Insulation resistance: More than 500M ohms at DC 100V

3. Operable temperature range :  $-20^{\circ}$ C To +70°C

4. Storage temperature range :  $-40^{\circ}$ C To  $+85^{\circ}$ C

4. Mechanical Data

4.1 Sealing Test : Reduced Pressure (260mmHg of mercury)

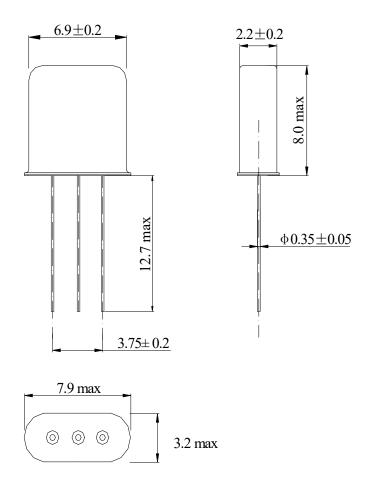
5. Dimensions and marking : Refer to page. 3

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## **MARKING & DIMENSIONS**

\*Appearance: Mark Shall Be Clear, Appearance Shall Be Smooth And No Damage.

\*Dimensions: Unit: mm



\*Marking should be printed as following:

Logo, Nominal Frequency

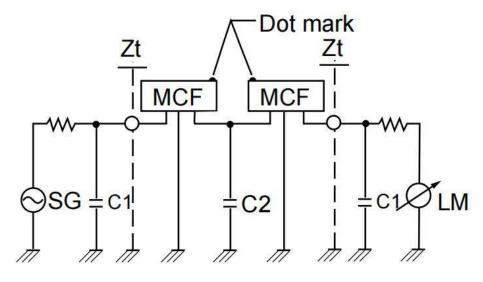
Logo: FT

Nominal Frequency:

Marking: Laser marking or lnk marking.

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## **TEST CIRCUIT**



4-POLE MCF Zt: Terminating Impedance

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	6.MECHANICAL/ENVIRONMENTAL CHARACTERISTICS		
NO.	ITEM	SPECIFICATIONS	
6.1	Resistance to Cold	The units should satisfy its frequency and resistance specifications stated in Table 1 after being subjected to stand at -40±3℃ for 2 hours. The units are then allowed to stand at room temperature for approx 2 hours before checking.	
6.2	Resistance to Heat	The units should satisfy its frequency and resistance specifications stated in Table 1 after being subjected to stand at 100±2°C for 2 hours. The units are then allowed to stand at room temperature for approx 2 hours before checking.	
6.3	Temperature Cycle	The units should satisfy its frequency and resistance specifications stated in Table 1 after the units are subjected to stand in a Low Temperature Chamber at -40±3°C for 30 minutes and to stand in a High Temperature Chamber at 100 ±2°C for 30 minutes, with 2 to 3 minutes standby at room temperature in between the chamber transfers.  This consist of one cycle; and units are subjected continuously for 5 cycles. After cycling, the units are allowed to stand at room temperature for approx 2 hours before checking.	
6.4	Aging	The units should satisfy its frequency and resistance specifications stated in Table 1 after the units are subjected to stand 720 (30 days) ±12 hours in an 85±3°C chamber. The units are allowed to stand at room temperature approx 2 hours before checking.	
6.5	Resistance to Damp	The units should satisfy its frequency and resistance specifications stated in Table 1 after the units are subjected to stand in the test chamber capable of maintaining 60±2°C temperature and 90 to 95%(RH) relative humidity for 500 hours. The units are then allowed to stand for approx 2 hours in room temperature before checking	
6.6	Bending Strength of Lead Wire Termination	The unit's lead wire should withstand a weight of 450g in mass suspended from its original draw-out axis, and turning the body at a bending rate of 2 to 3 secs. until it IS approx 90° from the original axis; and returning back to its original position at the same bending rate.  After this, the same method is repeated on the opposite 90° position. There should be no abnormalities detected on the unit.	

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6.7	Tensile Strength Termination	The units should withstand a tensile force applied to the termination in the direction of its draw-out axis of up to 900g maintained as is for 30±5 seconds. There should be no abnormalities detected on the unit.
6.8	Solder ability	Under JIS C 5033, at least 90% of the lead wire periphery surface is covered with new solder up to the point where it is dipped on a molten solder.
6.9	Resistance to Soldering Heat	The units are measured for its frequency and resistance in accordance with Table 1 after immersion into molten solder with a temperature of 350±10℃ for 3 to 4 seconds and at a depth up to a point 2.0 to 2.5 mm from the base root.
6.10	Dropping Test	<ul> <li>Unit Drop Test</li> <li>The units are measured for its frequency and resistance in accordance with Table 1 after allowing the units to fall freely from 20 cm of height 3 times on a firm wood .</li> <li>Shipping Carton Drop Test</li> <li>The units are measured for its frequency and resistance in accordance with Table 1 after dropping the units packaged inside a shipping carton box (randomly positioned) from a 50 cm height in each planar sides of the carton on a concrete floor.</li> </ul>
6.11	Vibration Test	The units are measured for its frequency and resistance in accordance with Table 1 after subjecting to 2 hours of vibration with 1.5 mmp-p amplitude with 10-55-10Hz frequency sweep within 1 minute. Three perpendicular plane (axes) of vibration are available; however each unit is allowed to vibrate in only one plane, thus each plane requires approx 1/3 of the total units.

TABLE 1		
Electrical Specification	Should satisfy stated in 2.3 2.4 2.5 2.6	
	Should satisfy stated in 2.7 2.10	

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